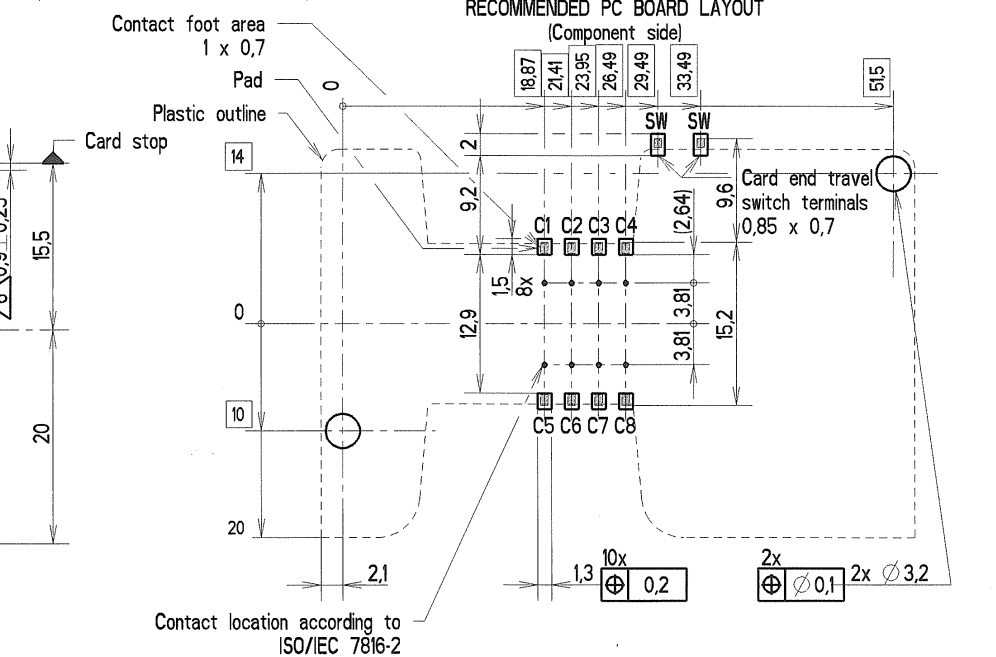
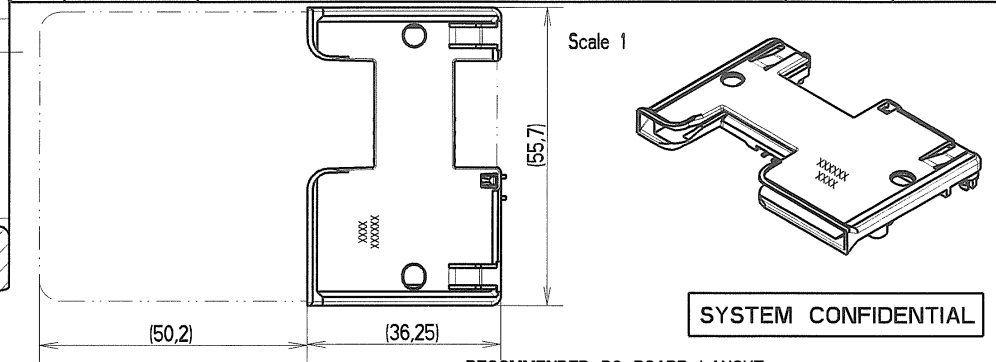
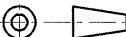
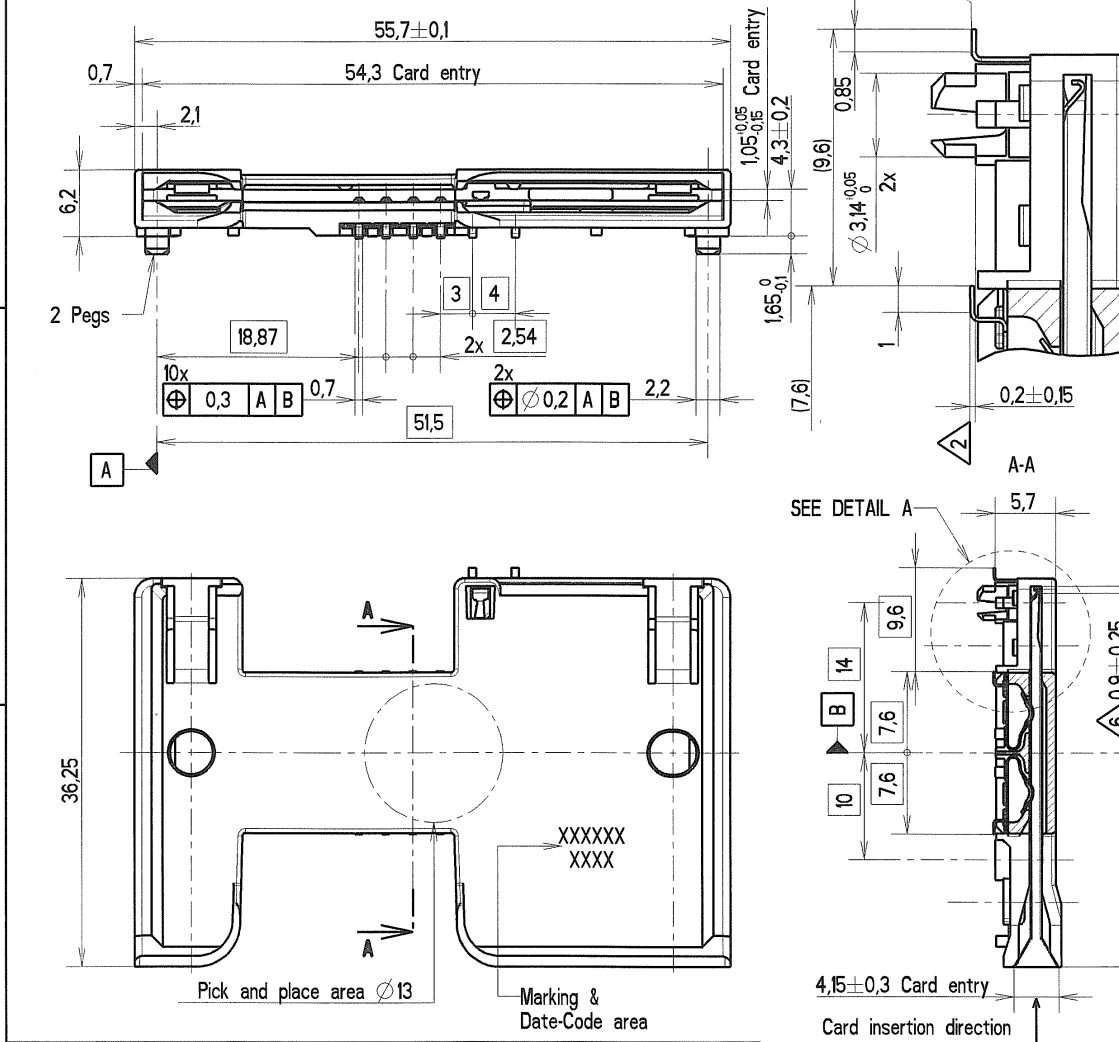


REV.	N° DCR	NATURE DE LA MODIFICATION	DATE	VISA
B	ECR-1406	References table added ; designation and marking updated	11/09/2007	V.P
C	ECR-1922	Part number Y1112-2013CPLFT added	25/02/2008	
D	ECR-2182	Designation updated	07/05/2008	CD



MATIERE		TRAITEMENT			PROTECTION		
SAUF INDIQUE : -COTES DONNEES AVANT PROTECTION -BAVURES ET ARETES VIVES SUPPRIMEES		TOL. LINEAIRE ± 0,1		TOL. ANGULAIRE ± 2 °		DIMENSIONS CRITIQUES ▼	
		ETAT DE SURFACE Ra		µ		DIMENSIONS SPC ▼	
DESSINE	PAILLE V. DATE 03/07/2007	ANALYSE	Y	TAB. FAM.	Y	PRO/E	Y
VERIFE	PINON G. DATE 07/05/2008	LANGAGE E					
APPROUVE	KUBAT L. DATE 07/05/2008	REPLACE					
 C&K Components		PROJECTION 1-ER DIEDRE 		DESIGNATION CCM01-2013xPLFT 2 pegs 3,14 mm			
		ECHELLE 2					
BP 359 - 39105 Dole - FRANCE -		TAILLE	FEUILLE	NUMERO	REV		
		A3	1 / 1	CU	1112MIY2013 D		



Packaging	Packaging drawing	Marking	Designation	Part Number
Tray 30 parts	030278Y0043	2013TP	CCM01-2013AP LFT T30/Y1112-2013APLFT	
Tray 25 parts	030278Y0064		CCM01-2013CP LFT T25/Y1112-2013CPLFT	
Reel	030278Y0059		CCM01-2013BP LFT R201/Y1112-2013BPLFT	

- Notes :
- 1 - Termination to PCB : SMT reflow soldering
Temperature/time profile according to :
C&K PS-LF-001 specification.
Since there are no boardlocks , the connector must be held in place on the PCB across the top face of the cover.
 - 2 - Level of each contact tail compared to the nearest plastic stand-off.
Coplanarity of metal soldering surfaces : 0,15 mm
 - 3 - Recommendation for solder paste thickness > 0,2 mm.
 - 4 - 2,5 microns min tin plating on contact terminal areas.
0,1 microns min gold plating on switch terminal areas.
 - 5 - Contact forces :
- max 0,5 N per contact with max. card thickness.
- min 0,2 N per contact with min. card thickness.
 - 6 - Card end travel switch NO activates when the sliding card is 0,9 mm from the card stop.
 - 7 - In case of customer accessories integration requesting an interface with CCM, please ask C&K for a 3D model.